### 8-Bit I/O Expander with Open-Drain Outputs

#### **Features**

- 8-bit remote bidirectional I/O port:
  - I/O pins default to input
- · Open-drain outputs:
  - 5.5V tolerant
  - 25 mA sink capable (per pin)
  - 200 mA total
- High-speed I<sup>2</sup>C<sup>™</sup> interface: (MCP23009)
  - 100 kHz
  - 400 kHz
  - 3.4 MHz
- High-speed SPI interface: (MCP23S09)
  - 10 MHz
- Single hardware address pin: (MCP23009)
  - Voltage input to allow up to eight devices on the bus
- · Configurable interrupt output pins:
  - Configurable as active-high, active-low or open-drain

- Configurable interrupt source:
  - Interrupt-on-change from configured defaults or pin change
- Polarity inversion register to configure the polarity of the input port data
- · External reset input
- · Low standby current:
  - $1 \mu A (-40^{\circ}C \le TA \le +85^{\circ}C)$
  - $6 \mu A (+85^{\circ}C \le TA \le +125^{\circ}C)$
- · Operating voltage:
  - 1.8V to 5.5V

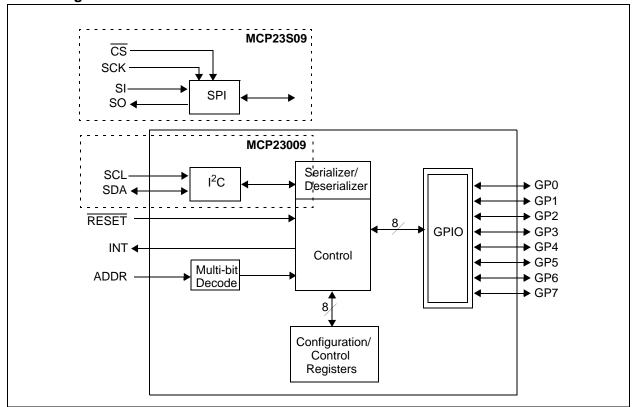
#### **Packages**

18-pin PDIP (300 mil)

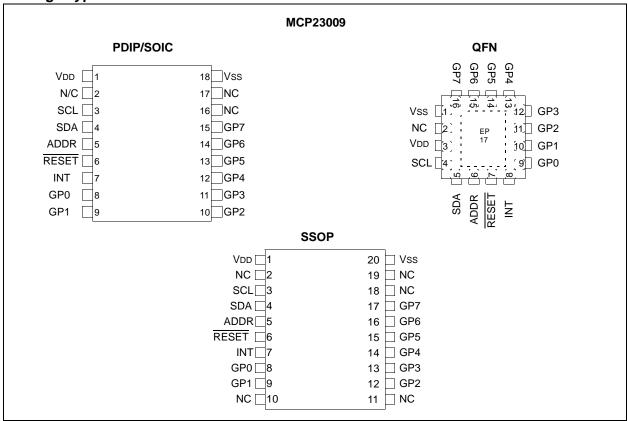
18-pin SOIC (300 mil)

20-pin SSOP

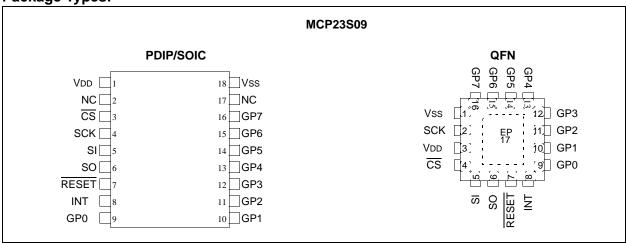
#### **Block Diagram**



#### **Package Types:**



#### **Package Types:**



#### 1.0 DEVICE OVERVIEW

The MCP23X09 device provides 8-bit, general purpose parallel I/O expansion for I<sup>2</sup>C bus or SPI applications. The two devices differ only in the serial interface.

- MCP23009 I<sup>2</sup>C interface
- MCP23S09 SPI interface

The MCP23X09 consists of multiple 8-bit configuration registers for input, output and polarity selection. The system master can enable the I/Os as either inputs or outputs by writing the I/O configuration bits. The data for each input or output is kept in the corresponding input or output register. The polarity of the input port register can be inverted with the polarity inversion register. All registers can be read by the system master.

The interrupt output can be configured to activate under two conditions (mutually exclusive):

- When any input state differs from its corresponding input port register state. This is used to indicate to the system master that an input state has changed.
- 2. When an input state differs from a preconfigured register value (DEFVAL register).

The Interrupt Capture register captures port values at the time of the interrupt, thereby saving the condition that caused the interrupt.

The Power-on Reset (POR) sets the registers to their default values and initializes the device state machine.

The hardware address pin is used to determine the device address.

#### 1.1 Pin Descriptions

TABLE 1-1: I<sup>2</sup>C PINOUT DESCRIPTION (MCP23009)

Pin Name	18L PDIP/ SOIC	20L SSOP	Pin Type	Standard Function			
VDD	1	1	Р	Power			
Vss	18	20	Р	Ground			
SCL	3	3	ı	Serial clock input			
SDA	4	4	I/O	Serial data I/O			
ADDR	5	5	I	Hardware address pin allows up to 8 slave devices on the bus			
RESET	6	6	I	Hardware reset			
INT	7	7	0	Interrupt output for port. Can be configured as active high, active low, or opendrain.			
GP0	8	8	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.			
GP1	9	9	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.			
GP2	10	12	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.			
GP3	11	13	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.			
GP4	12	14	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.			
GP5	13	15	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.			
GP6	14	16	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.			
GP7	15	17	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.			
NC	2, 16, 17	2,10, 11,19,18		Not connected			
EP	_			Exposed Thermal Pad (EP). Do not electrically connect. Can connect to Vss.			

TABLE 1-1: SPI PINOUT DESCRIPTION (MCP23S09)

Pin Name	18L PDIP/ SOIC	16L QFN	Pin Type	Standard Function
VDD	1	3	Р	Power (high current capable)
Vss	18	1	Р	Ground (high current capable)
CS	3	4	I	Chip select
SCK	4	2	I	Serial clock input
SI	5	5	I	Serial data input
SO	6	6	0	Serial data out
RESET	7	7	I	Hardware reset (must be externally biased)
INT	8	8	0	Interrupt output for port. Can be configured as active high, active low, or open-drain.
GP0	9	9	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GP1	10	10	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GP2	11	11	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GP3	12	12	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GP4	13	13	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GP5	14	14	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GP6	15	15	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GP7	16	16	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
NC	2, 17	_		Not connected
EP	_	17	_	Exposed Thermal Pad (EP). Do not electrically connect, Can connect to Vss.

#### 1.2 Power-on Reset (POR)

The on-chip POR circuit holds the device in reset until VDD has reached a high enough voltage to deactivate the POR circuit (i.e., release the device from reset). The maximum VDD rise time is specified in the electrical specification section.

When the device exits the POR condition (releases reset), device operating parameters (i.e., voltage, temperature, serial bus frequency, etc.) must be met to ensure proper operation.

#### 1.3 Serial Interface

This block handles the functionality of the  $I^2C$  (MCP23009) or SPI (MCP23S09) interface protocol. The MCP23X09 contains eleven (11) individual registers which can be addressed through the Serial Interface block (Table 1-2).

TABLE 1-2: REGISTER ADDRESSES

Address	Access to:
00h	IODIR
01h	IPOL
02h	GPINTEN
03h	DEFVAL
04h	INTCON
05h	IOCON
06h	GPPU
07h	INTF
08h	INTCAP (Read-only)
09h	GPIO
0Ah	OLAT

## 1.3.1 BYTE MODE AND SEQUENTIAL MODE

The MCP23X09 has the ability to operate in "Byte Mode" or "Sequential Mode" (IOCON.SEQOP). Byte mode and sequential mode are not to be confused with I<sup>2</sup>C byte operations and sequential operations. The modes explained here relate to the device's internal address pointer and whether or not it is incremented after each byte is clocked on the serial interface.

Byte Mode disables automatic address pointer incrementing. When operating in Byte Mode, the MCP23X09 does not increment its internal address counter after each byte during the data transfer. This gives the ability to continually access the same address by providing extra clocks (without additional control bytes). This is useful for polling the GPIO register for data changes or for continually writing to the output latches.

**Sequential Mode** enables automatic address pointer incrementing. When operating in Sequential Mode, the MCP23X09 increments its address counter after each

byte during the data transfer. The address pointer automatically rolls over to address 00h after accessing the last register.

These two modes are not to be confused with single writes/reads and continuous writes/reads which are serial protocol sequences. For example, the device may be configured for Byte Mode and the master may perform a continuous read. In this case, the MCP23X09 would not increment the address pointer and would repeatedly drive data from the same location.

#### 1.3.2 I<sup>2</sup>C INTERFACE

#### 1.3.2.1 I<sup>2</sup>C Write Operation

The I<sup>2</sup>C write operation includes the control byte and register address sequence, as shown in the bottom of Figure 1-1. This sequence is followed by eight bits of data from the master and an Acknowledge (ACK) from the MCP23009. The operation is ended with a stop (P) or restart (SR) condition being generated by the master.

Data is written to the MCP23009 after every byte transfer. If a stop or restart condition is generated during a data transfer, the data will not be written to the MCP23009.

Both "byte mode" and "sequential mode" are supported by the MCP23009. If sequential mode is enabled (default), the MCP23009 increments its address counter after each ACK during the data transfer.

#### 1.3.2.2 I<sup>2</sup>C Read Operation

 $I^2C$  read operations include the control byte sequence, as shown in the bottom of Figure 1-1. This sequence is followed by another control byte (including the Start condition and ACK) with the R/W bit equal to a logic one (R/W = 1). The MCP23009 then transmits the data contained in the addressed register. The sequence is ended with the master generating a Stop or Restart condition.

#### 1.3.2.3 I<sup>2</sup>C Sequential Write/Read

For sequential operations (Write or Read), instead of transmitting a Stop or Restart condition after the data transfer, the master clocks the next byte pointed to by the address pointer (see **Section 1.3.1** "**Byte Mode and Sequential Mode**" for details regarding sequential operation control).

The sequence ends with the master sending a Stop or Restart condition.

The MCP23009 address pointer will roll over to address zero after reaching the last register address.

Refer to Figure 1-1.

#### 1.3.3 SPI INTERFACE

The MCP23S09 operates in Mode 0,0 and Mode 1,1. The difference between the two modes is the idle state of the clock.

Mode 0,0: The idle state of the clock is LOW. Input data is latched on the rising edge of the clock; output data is driven on the falling edge of the clock.

Mode 1,1: The idle state of the clock is HIGH. Input data is latched on the rising edge of the clock; output data is driven on the falling edge of the clock.

#### 1.3.3.1 SPI Write Operation

The SPI write operation is started by lowering  $\overline{CS}$ . The write command (slave address with R/W bit cleared) is then clocked into the device. The opcode is followed by an address and at least one data byte.

#### 1.3.3.2 SPI Read Operation

The SPI read operation is started by lowering  $\overline{CS}$ . The SPI read command (slave address with R/W bit set) is then clocked into the device. The opcode is followed by an address, with at least one data byte being clocked out of the device.

#### 1.3.3.3 SPI Sequential Write/Read

For sequential operations, instead of deselecting the device by raising  $\overline{CS}$ , the master clocks the next byte pointed to by the address pointer. (see **Section 1.3.1** "Byte Mode and Sequential Mode" for details regarding sequential operation control).

The sequence ends by the raising of  $\overline{CS}$ .

The MCP23S09 address pointer will roll over to address zero after reaching the last register address.

MCP23009 I<sup>2</sup>C™ DEVICE PROTOCOL FIGURE 1-1: S - Start SR - Restart DIN DIN Р s OP **ADDR** - Stop Р w - Write ►SR OP Dout Dout R R - Read **►**SR OP W **ADDR** DIN - Device opcode OP **ADDR** - Device address ₽ - Data out from MCP23009 **D**out DIN - Data in to MCP23009 Dout Dout Р S OP R Dout **D**out **►**SR OP R P DIN Dout SR OP W **ADDR** P **Byte and Sequential Write** DIN Р Byte S OP **ADDR** DIN DIN ► P S OP **ADDR** Sequential **Byte and Sequential Read** Byte S W Dout P OP ADDR OP R Sequential S OP W **ADDR ►**SR OP R **D**OUT Dout **►** P

#### 1.4 Multi-bit Address Decoder

The ADDR pin is used to set the slave address of the MCP23009 (I<sup>2</sup>C only) to allow up to eight devices on the bus using only a single pin. Typically, this would require three pins.

The multi-bit Address Decoder employs a basic FLASH ADC architecture (Figure 1-4). The seven comparators generate 8 unique values based on the analog input. This value is converted to a 3-bit code which corresponds to the address bits (A2, A1, A0) in the serial OPCODE.

## Sequence of Operation (see Figure 1-5 for timings):

 Upon power up (after VDD stabilizes) the module becomes active after time tADEN. Note, the analog value on the ADDR pin must be stable before this point to ensure accurate address assignment.

- 2. The 3-bit address is latched after tADDRLAT
- 3. The module powers down after the first rising edge of the serial clock is detected (tADDIS).

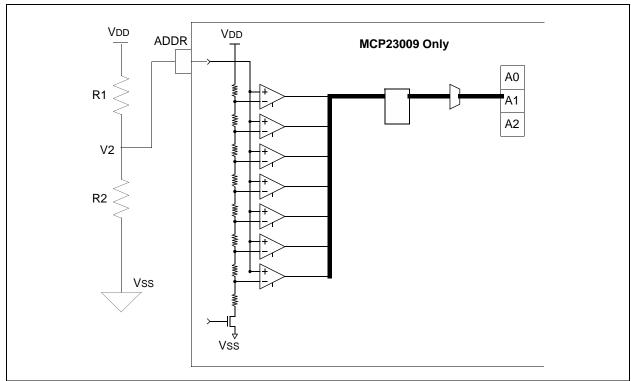
Once the address bits are latched, the device will keep the slave address until a POR or reset condition occurs.

#### 1.4.1 CALCULATING VOLTAGE ON ADDR

When calculating the required voltage on the ADDR pin (V2), the set point should be the mid-point of the LSb of the ADC.

The examples in Figure 1-2 and Figure 1-3 show how to determine the mid point voltage (V2) and the range of voltages based on a voltage divider circuit. The maximum tolerance is 20%, however, it is recommended to use 5% tolerance worst case (10% total tolerance).

FIGURE 1-2: VOLTAGE DIVIDER EXAMPLE



#### FIGURE 1-3: VOLTAGE AND CODE EXAMPLE

Assume:

n = A2, A1, A0 in opcode ratio = R2/(R1+R2) V2 = voltage on ADDR pin V2(min) = V2 - (VDD/8) x %tolerance V2(max) = V2 + (VDD/8) x %tolerance

			VDD=	10% Tolera	ance (total)	
n	R2=2n+1	R1=16-R2	R2/(R1+R2)	V2	V2(min)	V2(max)
0	1	15	0.0625	0.113	0.00	0.14
1	3	13	0.1875	0.338	0.32	0.36
2	5	11	0.3125	0.563	0.54	0.59
3	7	9	0.4375	0.788	0.77	0.81
4	9	7	0.5625	1.013	0.99	1.04
5	11	5	0.6875	1.238	1.22	1.26
6	13	3	0.8125	1.463	1.44	1.49
7	15	1	0.9375	1.688	1.67	1.80

			10% Tolera	nce (total)		
n	R2=2n+1	R1=16-R2	R2/(R1+R2)	V2	V2(min)	V2(max)
0	1	15	0.0625	0.169	0.00	0.19
1	3	13	0.1875	0.506	0.48	0.53
2	5	11	0.3125	0.844	0.82	0.87
3	7	9	0.4375	1.181	1.16	1.20
4	9	7	0.5625	1.519	1.50	1.54
5	11	5	0.6875	1.856	1.83	1.88
6	13	3	0.8125	2.194	2.17	2.22
7	15	1	0.9375	2.531	2.51	2.70

			VDD=	3.3	10% Tolera	ince (total)
n	R2=2n+1	R1=16-R2	R2/(R1+R2)	V2	V2(min)	V2(max)
0	1	15	0.0625	0.206	0.00	0.23
1	3	13	0.1875	0.619	0.60	0.64
2	5	11	0.3125	1.031	1.01	1.05
3	7	9	0.4375	1.444	1.42	1.47
4	9	7	0.5625	1.856	1.83	1.88
5	11	5	0.6875	2.269	2.25	2.29
6	13	3	0.8125	2.681	2.66	2.70
7	15	1	0.9375	3.094	3.07	3.30

			VDD=	5.5	10% Tolera	ince (total)
n	R2=2n+1	R1=16-R2	R2/(R1+R2)	V2	V2(min)	V2(max)
0	1	15	0.0625	0.344	0.00	0.37
1	3	13	0.1875	1.031	1.01	1.05
2	5	11	0.3125	1.719	1.70	1.74
3	7	9	0.4375	2.406	2.38	2.43
4	9	7	0.5625	3.094	3.07	3.12
5	11	5	0.6875	3.781	3.76	3.80
6	13	3	0.8125	4.469	4.45	4.49
7	15	1	0.9375	5.156	5.13	5.50

FIGURE 1-4: FLASH ADC BLOCK DIAGRAM

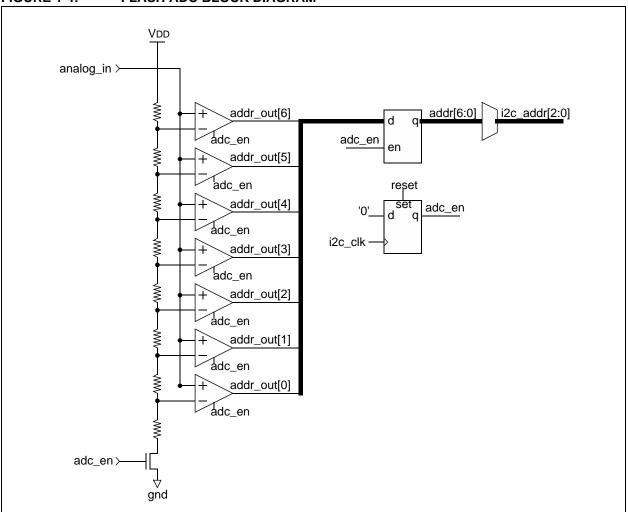
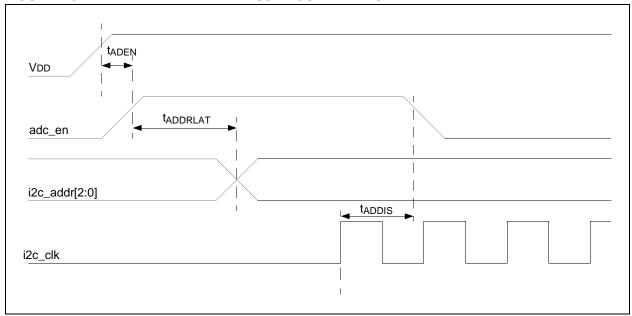


FIGURE 1-5: HARDWARE ADDRESS DECODE TIMING



# 1.4.2 ADDRESSING I<sup>2</sup>C DEVICES (MCP23009)

The MCP23009 is a slave I<sup>2</sup>C device that supports 7-bit slave addressing, with the read/write bit filling out the control byte. The slave address contains four fixed bits and three user-defined hardware address bits (configured via ADDR pin). Figure 1-6 shows the control byte format.

## 1.4.3 ADDRESSING SPI DEVICES (MCP23S09)

The MCP23S09 is a slave SPI device. The slave address contains seven fixed bits(no address bits) with the read/write bit filling out the control byte. Figure 1-7 shows the control byte format.

FIGURE 1-6: I<sup>2</sup>C™ CONTROL BYTE FORMAT

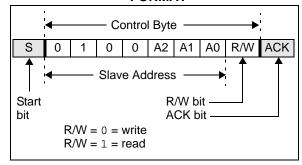
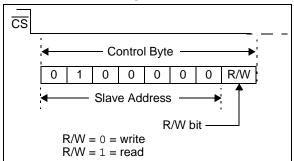
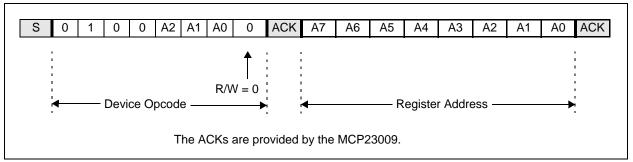


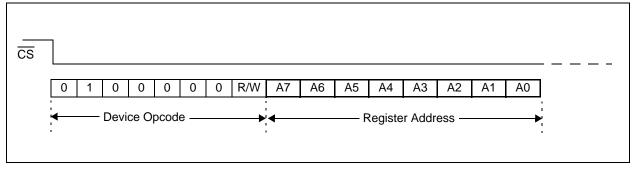
FIGURE 1-7: SPI CONTROL BYTE FORMAT



#### FIGURE 1-8: I<sup>2</sup>C™ ADDRESSING REGISTERS



#### FIGURE 1-9: SPI ADDRESSING REGISTERS



#### 1.5 GPIO Port

The GPIO module is a general purpose 8-bit wide bidirectional port.

The outputs are open-drain.

The GPIO module contains the data ports (GPIOn), internal pull up resistors and the Output Latches (OLATn).

The pull up resistors are individually configured and can be enabled when the pin is configured as an input or output.

Reading the GPIOn register reads the value on the port. Reading the OLATn register only reads the latches, not the actual value on the port.

Writing to the GPIOn register actually causes a write to the latches (OLATn). Writing to the OLATn register forces the associated output drivers to drive to the level in OLATn. Pins configured as inputs turn off the associated output driver and put it in high-impedance.

# 1.6 Configuration and Control Registers

There are eleven (11) registers associated with the MCP23X09 as shown in Table 1-3.

TABLE 1-3: CONFIGURATION AND CONTROL REGISTER

Register Name	Address (hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	POR/RST value
IODIRA	00	107	IO6	IO5	IO4	IO3	IO2	IO1	IO0	1111 1111
IPOLA	01	IP7	IP6	IP5	IP4	IP3	IP2	IP1	IP0	0000 0000
GPINTENA	02	GPINT7	GPINT6	GPINT5	GPINT4	GPINT3	GPINT2	GPINT1	GPINT0	0000 0000
DEFVALA	03	DEF7	DEF6	DEF5	DEF4	DEF3	DEF2	DEF1	DEF0	0000 0000
INTCONA	04	IOC7	IOC6	IOC5	IOC4	IOC3	IOC2	IOC1	IOC0	0000 0000
IOCON	05	_	_	SEQOP	_	_	ODR	INTPOL	INTCC	0000 0000
GPPUA	06	PU7	PU6	PU5	PU4	PU3	PU2	PU1	PU0	0000 0000
INTFA	07	INT7	INT6	INT5	INT4	INT3	INT2	INT1	INTO	0000 0000
INTCAPA	08	ICP7	ICP6	ICP5	ICP4	ICP3	ICP2	ICP1	ICP0	0000 0000
GPIOA	09	GP7	GP6	GP5	GP4	GP3	GP2	GP1	GP0	0000 0000
OLATA	0A	OL7	OL6	OL5	OL4	OL3	OL2	OL1	OL0	0000 0000

#### 1.6.1 I/O DIRECTION REGISTER

Controls the direction of the data I/O.

When a bit is set, the corresponding pin becomes an input. When a bit is clear, the corresponding pin becomes an output.

#### REGISTER 1-2: IODIR – I/O DIRECTION REGISTER

| R/W-1 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| 107   | IO6   | IO5   | 104   | IO3   | IO2   | IO1   | IO0   |
| bit 7 |       |       |       |       |       |       | bit 0 |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **IO7:IO0:** Controls the direction of data I/O <7:0>

1 = Pin is configured as an input.0 = Pin is configured as an output.

#### 1.6.2 INPUT POLARITY REGISTER

This register allows the user to configure the polarity on the corresponding GPIO port bits.

If a bit is set, the corresponding GPIO register bit will reflect the inverted value on the pin.

#### REGISTER 1-3: IPOL – INPUT POLARITY PORT REGISTER

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| IP7   | IP6   | IP5   | IP4   | IP3   | IP2   | IP1   | IP0   |
| bit 7 |       |       |       |       |       |       | bit 0 |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **IP7:IP0:** Controls the polarity inversion of the input pins <7:0>

1 = GPIO register bit will reflect the opposite logic state of the input pin.

0 = GPIO register bit will reflect the same logic state of the input pin.

## 1.6.3 INTERRUPT-ON-CHANGE CONTROL REGISTER

The GPINTEN register controls the interrupt-onchange feature for each pin.

If a bit is set, the corresponding pin is enabled for interrupt-on-change. The DEFVAL and INTCON registers must also be configured if any pins are enabled for interrupt-on-change.

#### REGISTER 1-4: GPINTEN – INTERRUPT-ON-CHANGE PINS

| R/W-0  |
|--------|--------|--------|--------|--------|--------|--------|--------|
| GPINT7 | GPINT6 | GPINT5 | GPINT4 | GPINT3 | GPINT2 | GPINT1 | GPINT0 |
| bit 7  |        |        |        |        |        |        | bit 0  |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **GPINT7:GPINT0:** General purpose I/O interrupt-on-change pins <7:0>

1 = Enable GPIO input pin for interrupt-on-change event

0 = Disable GPIO input pin for interrupt-on-change event.

Refer to INTCON and DEFVAL.

## 1.6.4 DEFAULT COMPARE REGISTER FOR INTERRUPT-ON-CHANGE

The default comparison value is configured in the DEFVAL register. If enabled (via GPINTEN and INTCON) to compare against the DEFVAL register, an opposite value on the associated pin will cause an interrupt to occur.

#### REGISTER 1-5: DEFVAL – DEFAULT VALUE REGISTER

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| DEF7  | DEF6  | DEF5  | DEF4  | DEF3  | DEF2  | DEF1  | DEF0  |
| bit 7 |       |       |       |       |       |       | bit 0 |

Legend:				
R = Readable bit	W = Writable bit	W = Writable bit U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7-0 **DEF7:DEF0:** Sets the compare value for pins configured for interrupt-on-change from defaults <7:0>. Refer to INTCON.

If the associated pin level is the opposite from the register bit, an interrupt occurs.

Refer to INTCON and GPINTEN.

#### 1.6.5 INTERRUPT CONTROL REGISTER

The INTCON register controls how the associated pin value is compared for the interrupt-on-change feature. If a bit is set, the corresponding I/O pin is compared against the associated bit in the DEFVAL register. If a bit value is clear, the corresponding I/O pin is compared against the previous value.

#### REGISTER 1-6: INTCON - INTERRUPT-ON-CHANGE CONTROL REGISTER

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| IOC7  | IOC6  | IOC5  | IOC4  | IOC3  | IOC2  | IOC1  | IOC0  |
| bit 7 |       |       |       |       |       |       | bit 0 |

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7-0 **IOC7:IOC0:** Controls how the associated pin value is compared for interrupt-on-change <7:0>.

1 = Pin value is compared against the associated bit is DEFVAL register

0 = Pin value is compared against the previous pin value.

Refer to DEFVAL and GPINTEN.

#### 1.6.6 CONFIGURATION REGISTER

The Sequential Operation (**SEQOP**) controls the incrementing function of the address pointer. If the address pointer is disabled, the address pointer does not automatically increment after each byte is clocked during a serial transfer. This feature is useful when it is desired to continuously poll (read) or modify (write) a register.

The Open-Drain (**ODR**) control bit enables/disables the INT pin for open-drain configuration.

The Interrupt Polarity (**INTPOL**) sets the polarity of the INT pin. This bit is functional only when the ODR bit is cleared, configuring the INT pin as active push-pull.

The Interrupt Clearing Control (INTCC) configures how interrupts are cleared. When set (INTCC = 1), the interrupt is cleared when the INTCAP register is read. When cleared (INTCC = 0), the interrupt is cleared when the GPIO register is read.

The interrupt can only be cleared when the interrupt condition is inactive. Refer to **Section 1.7.4** "Clearing Interrupts" for details.

#### REGISTER 1-7: IOCON – I/O EXPANDER CONFIGURATION REGISTER

U-0	U-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0
-	-	SEQOP	-	-	ODR	INTPOL	INTCC
bit 7							bit 0

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit,	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7	Unimplemented: Reads as 0
bit 6	Unimplemented: Reads as 0
bit 5	SEQOP: Sequential Operation mode bit.
	<ul> <li>1 = Sequential operation disabled, address pointer does not increment.</li> <li>0 = Sequential operation enabled, address pointer increments.</li> </ul>
bit 4	Unimplemented: Reads as 0
bit 3	Unimplemented: Reads as 0
bit 2	<b>ODR:</b> Configures the INT pin as an open-drain output.
	<ul><li>1 = Open-drain output (overrides the INTPOL bit).</li><li>0 = Active driver output (INTPOL bit sets the polarity).</li></ul>
bit 1	INTPOL: Sets the polarity of the INT output pin.
	<ul><li>1 = Active-high.</li><li>0 = Active-low.</li></ul>
bit 0	INTCC: Interrupt Clearing Control  1 = Reading INTCAP register clears the interrupt  0 = Reading GPIO register clears the interrupt

## 1.6.7 PULL-UP RESISTOR CONFIGURATION REGISTER

The GPPU register controls the pull-up resistors for the port pins. If a bit is set the corresponding port pin is internally pulled up with an internal resistor.

REGISTER 1-8: GPPU – GPIO PULL-UP RESISTOR REGISTER

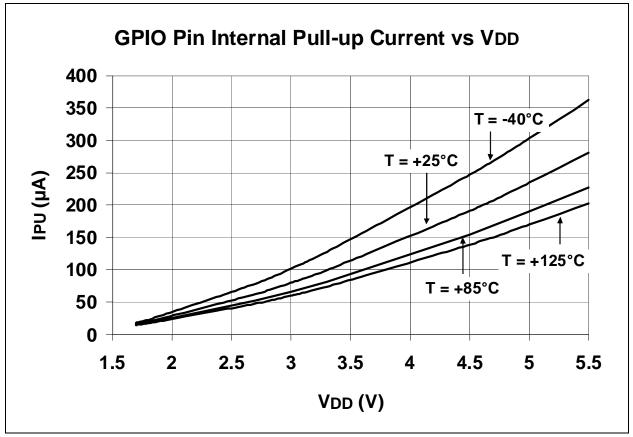
| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| PU7   | PU6   | PU5   | PU4   | PU3   | PU2   | PU1   | PU0   |
| bit 7 |       |       |       |       |       |       | bit 0 |

Legend:R = Readable bitW = Writable bitU = Unimplemented bit, read as '0'-n = Value at POR'1' = Bit is set'0' = Bit is clearedx = Bit is unknown

bit 7-0 **PU7:PU0:** Controls the internal pull-up resistors on each pin (when configured as an input or output) <7:0>.

1 = Pull-up enabled.0 = Pull-up disabled.

FIGURE 1-10: TYPICAL PERFORMANCE CURVE FOR THE INTERNAL PULL-UP RESISTORS



#### 1.6.8 INTERRUPT FLAG REGISTER

The INTF register reflects the interrupt condition on the port pins of any pin that is enabled for interrupts via the GPINTEN register. A 'set' bit indicates that the associated pin caused the interrupt.

This register is 'read only'. Writes to this register will be ignored.

#### REGISTER 1-9: INTF - INTERRUPT FLAG REGISTER

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
INT7	INT6	INT5	INT4	INT3	INT2	INT1	INT0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **INT7:INT0:** Reflects the interrupt condition on the port. Will reflect the change only if interrupts are enabled (GPINTEN) <7:0>.

1 = Pin caused interrupt.

0 = Interrupt not pending.

#### 1.6.9 INTERRUPT CAPTURE REGISTER

The INTCAP register captures the GPIO port value at the time the interrupt occurred. The register is 'read only' and is updated only when an interrupt occurs. The register will remain unchanged until the interrupt is cleared via a read of INTCAP or GPIO.

#### REGISTER 1-10: INTCAP – INTERRUPT CAPTURED VALUE FOR PORT REGISTER

R-x	R-x	R-x	R-x	R-x	R-x	R-x	R-x
ICP7	ICP6	ICP5	ICP4	ICP3	ICP2	ICP1	ICP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	l as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **ICP7:ICP0:** Reflects the logic level on the port pins at the time of interrupt due to pin change <7:0>.

1 = Logic-high.

0 = Logic-low.

#### 1.6.10 PORT REGISTER

The GPIO register reflects the value on the port. Reading from this register reads the port. Writing to this register modifies the Output Latch (OLAT) register.

#### REGISTER 1-11: GPIO – GENERAL PURPOSE I/O PORT REGISTER

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| GP7   | GP6   | GP5   | GP4   | GP3   | GP2   | GP1   | GP0   |
| bit 7 |       |       |       |       |       |       | bit 0 |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	l as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **GP7:GP0:** Reflects the logic level on the pins <7:0>.

1 = Logic-high.

0 = Logic-low.

#### 1.6.11 OUTPUT LATCH REGISTER (OLAT)

The OLAT register provides access to the output latches. A read from this register results in a read of the OLAT and not the port itself. A write to this register modifies the output latches that modifies the pins configured as outputs.

#### REGISTER 1-12: OLAT – OUTPUT LATCH REGISTER 0

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| OL7   | OL6   | OL5   | OL4   | OL3   | OL2   | OL1   | OL0   |
| bit 7 |       |       |       |       |       |       | bit 0 |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **OL7:OL0:** Reflects the logic level on the output latch <7:0>.

1 = Logic-high.

0 = Logic-low.

#### 1.7 Interrupt Logic

If enabled, the MCP23X09 activates the INT interrupt output when one of the port pins changes state or when a pin does not match the pre-configured default. Each pin is individually configurable as follows:

- · Enable/disable interrupt via GPINTEN
- Can interrupt on either pin change or change from default as configured in DEFVAL

Both conditions are referred to as Interrupt on Change (IOC).

The Interrupt Control Module uses the following registers/bits:

- · GPINTEN Interrupt enable register
- INTCON Controls the source for the IOC
- DEFVAL Contains the register default for IOC operation
- IOCON (ODR and INTPOL) configures the INT pin as push-pull, open-drain, and active level (high or low).

#### 1.7.1 IOC FROM PIN CHANGE

If enabled, the MCP23X09 will generate an interrupt if a mismatch condition exists between the current port value and the previous port value. Only IOC enabled pins will be compared. See GPINTEN and INTCON registers.

#### 1.7.2 IOC FROM REGISTER DEFAULT

If enabled, the MCP23X09 will generate an interrupt if a mismatch occurs between the DEFVAL register and the port. Only IOC enabled pins will be compared. See GPINTEN, INTCON, and DEFVAL registers.

#### 1.7.3 INTERRUPT OPERATION

The INT interrupt output can be configured as "active low", "active high", or "open-drain" via the IOCON register.

Only those pins that are configured as an input (IODIR register) with interrupt-on-change (IOC) enabled (GPINTEN register) can cause an interrupt. Pins configured as an output have no effect on the interrupt output pin.

Input change activity on a port input pin that is enabled for IOC will generate an internal device interrupt and the device will capture the value of the port and copy it into INTCAP.

The first interrupt event will cause the port contents to be copied into the INTCAP register. Subsequent interrupt conditions on the port will not cause an interrupt to occur as long as the interrupt is not cleared by a read of INTCAP or GPIO.

#### 1.7.4 CLEARING INTERRUPTS

Note:

The interrupt will remain active until the INTCAP or GPIO register is read (depending on IOCON.INTCC). Writing to these registers will not affect the interrupt. The interrupt condition will be cleared after the LSb of the data is clocked out during a Read operation of GPIO or INTCAP (depending on IOCON.INTCC).

Assuming IOCON.INTCC = 0 (INT cleared on GPIO read): The value in INTCAP can be lost if GPIO is read before INTCAP while another IOC is pending. After reading GPIO, the interrupt will clear and then set due to the pending IOC, causing the INTCAP register to update.

#### 1.7.5 INTERRUPT CONDITIONS

There are two possible configurations to cause interrupts (configured via INTCON):

- Pins configured for interrupt-on-pin-change will cause an interrupt to occur if a pin changes to the opposite state. The default state is reset after an interrupt occurs. For example, an interrupt occurs by an input changing from 1 to 0. The new initial state for the pin is a logic 0.
- Pins configured for interrupt-on-change from register value will cause an interrupt to occur if the corresponding input pin differs from the register bit. The interrupt condition will remain as long as the condition exists, regardless if the INTAP or GPIO is read.

See Figure 1-11 and Figure 1-12 for more information on interrupt operations.

FIGURE 1-11: INTERRUPT-ON-PIN-CHANGE

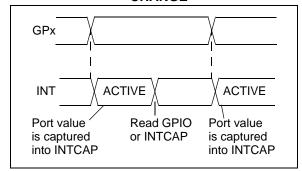
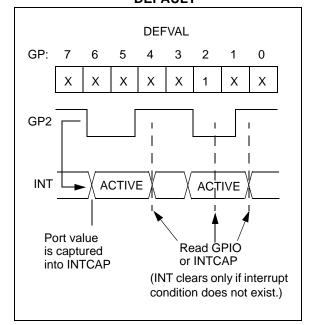


FIGURE 1-12: INTERRUPT-ON-CHANGE FROM REGISTER DEFAULT



#### 2.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings (†)

Ambient temperature under bias	40°C to +125°C
Storage temperature	-65°C to +150°C
Voltage on VDD with respect to Vss	-0.3V to +7.0V
Voltage on RESET with respect to Vss	0.3V to +14V
Voltage on all other pins with respect to Vss (except VDD and GPIOA/B)	0.6V to (VDD + 0.6V)
Voltage on GPIO Pins:	0.6V to 5.5V
Total power dissipation (Note 1)	700 mW
Maximum current out of Vss pin	200 mA
Maximum current into VDD pin	125 mA
Input clamp current, IiK (VI < 0 or VI > VDD)	±20 mA
Output clamp current, lok (Vo < 0 or Vo > VDD)	±20 mA
Maximum output current sunk by any Output pin	25 mA
Maximum output current sunk by any Output pin (VDD = 1.8V)	10 mA

**Note:** Power dissipation is calculated as follows:

 $Pdis = VDD \ x \ \{IDD - \sum IOH\} + \sum \{(VDD-VOH) \ x \ IOH\} + \sum (VOL \ x \ IOL)$ 

<sup>†</sup> **NOTICE:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

#### 2.1 DC CHARACTERISTICS

DC Cha	racteristics		ng Conditions /DD ≤ 5.5V at -4			indicate	ed):
Param No.	Characteristic	Sym	Min	Typ <sup>(2)</sup>	Max	Units	Conditions
D001	Supply Voltage	Vdd	1.8	_	5.5	V	
D002	VDD Start Voltage to Ensure Power-on Reset	VPOR	_	Vss	_	V	
D003	VDD Rise Rate to Ensure Power-on Reset	SVDD	0.05	_	_	V/ms	Design guidance only. Not tested.
D004	Supply Current	IDD	_	_	1	mA	SCL/SCK = 1 MHz
D005	Standby (Idle) current	IDDS	_	_	1	μΑ	$-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$
			_	_	6	μΑ	+85°C ≤ TA ≤ +125°C
	Input Low-Voltage						
D031	CS, GPIO, SCL/SCK, SDA, SI, RESET	VIL	Vss	_	0.2 VDD	٧	
	Input High-Voltage						
D041	CS, SCL/SCK, SDA, SI, RESET	VIH	0.8 VDD	_	VDD	V	
	GPIO	ViH	0.8 VDD	_	5.5	V	
	Input Leakage Curren	t					
D060	I/O port pins	lı∟	_	_	±1	μΑ	$VSS \leq VPIN \leq VDD$ ,
	Output Leakage Curre	ent					
D065	I/O port pins	llo	_	_	±1	μΑ	$Vss \leq Vpin \leq Vdd,$
D070	GPIO internal pull-up current	IPU	_	220		μΑ	VDD = 5V, GP Pins = VSS Note 1
	Output Low-Voltage						
D080	GPIO	Vol	_	_	0.6	V	IOL = 8.5  mA, VDD = 4.5V (open-drain)
	INT		_	_	0.6	V	IOL = 1.6 mA, VDD = 4.5V
	SO, SDA		_	_	0.6	V	IOL = 3.0 mA, VDD = 1.8V
	SDA		_	_	0.8	V	IOL = 3.0  mA, VDD = 4.5V
-	Output High-Voltage						
D090	INT, SO	Voн	VDD - 0.7	-		V	IOH = -3.0 mA, VDD = 4.5V
			VDD - 0.7	_	_		IOH = $-400 \mu A$ , VDD = $1.8V$
	Capacitive Loading S	pecs on (	Output Pins	_			
D101	GPIO, SO, INT	Cio	_	_	50	pF	
D102	SDA	Св	_	_	400	pF	

Note 1: This parameter is characterized, not 100% tested.

<sup>2:</sup> Data in the Typical ("Typ") column is at 5V, +25°C unless otherwise stated.

#### 2.2 AC CHARACTERISTICS

FIGURE 2-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS

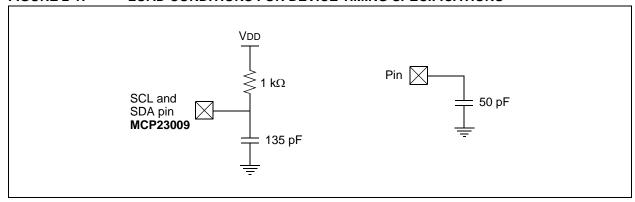


FIGURE 2-2: RESET AND DEVICE RESET TIMER TIMING

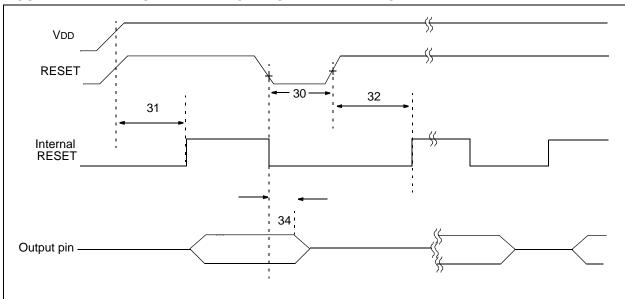


TABLE 2-1: RESET AND DEVICE RESET TIMER REQUIREMENTS

AC Charact	AC Characteristics Standard Operating Conditions (unless otherwise specified) $1.8V \le VDD \le 5.5V$ at $-40^{\circ}C \le TA \le +125^{\circ}C$ .							
Parameter No.	Sym	Characteristic	Min	Typ <sup>(2)</sup>	Max	Units	Conditions	
30	TRSTL	RESET Pulse Width (low)	1	_	_	μs	VDD = 5.0V	
32	THLD	Device active after reset high	_	0	_	μs	VDD = 5.0V	
31	TPOR	POR at device power up	_	20	_	μs	VDD = 5.0V	
34	Tioz	Output Hi-impedance from RESET Low	_	_	1	μs		

Note 1: This parameter is characterized, not 100% tested.

2: Data in the Typical ("Typ") column is at 5V, +25°C, unless otherwise stated.

#### TABLE 2-2: GP AND INT PINS

AC Characteristics Standard Operating Conditions (unless otherwise specified) $1.8V \le VDD \le 5.5V$ at $-40^{\circ}C \le TA \le +125^{\circ}C$ .							
Parameter No.	Sym	Characteristic	Min	Typ <sup>(2)</sup>	Max	Units	Conditions
50	tGPOV	Serial data to output valid	_	_	500	ns	
51	tintd	Interrupt pin disable time	_	_	600	ns	
52	tGPIV	GP input change to register valid	_	450	_	ns	Note 1
53	tGPINT	IOC event to INT active	_	_	600	ns	
54	tGLITCH	Glitch filter on GP pins	_	_	50	ns	Note 1

**Note 1:** This parameter is characterized, not 100% tested.

2: Data in the Typical ("Typ") column is at 5V, +25°C, unless otherwise stated.

#### FIGURE 2-3: GPIO AND INT TIMING

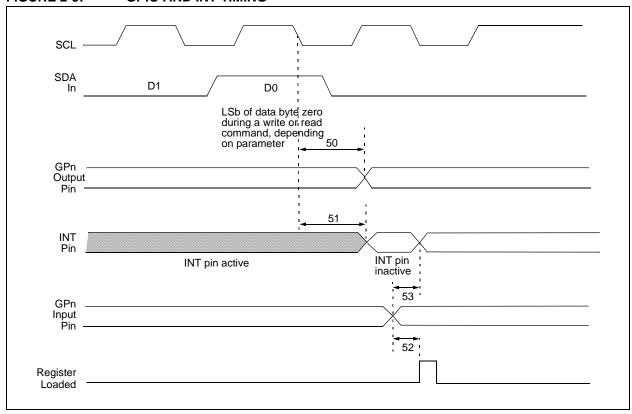


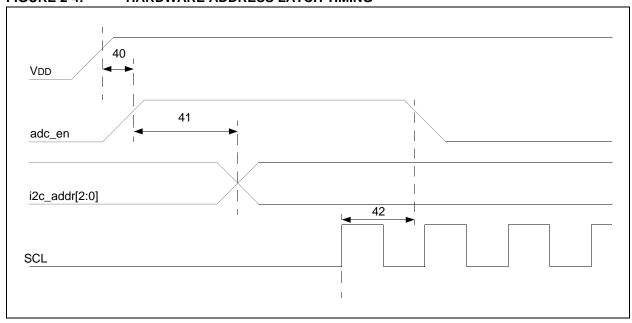
TABLE 2-3: HARDWARE ADDRESS LATCH TIMING

AC Charac	teristics	Standard Operating Conditions (unless otherwise specified) $.8V \le VDD \le 5.5V$ at $-40^{\circ}C \le TA \le +125^{\circ}C$ .						
Parameter No.	Sym	Characteristic	Min	Typ <sup>(2)</sup>	Max	Units	Conditions	
40	taden	Time from VDD stable after POR to ADC enable	_	0	_	μs	Note 1	
41	taddrlat	Time from ADC enable to address decode and latch	_	50	_	ns	Note 1	
42	taddis	Time from raising edge of serial clock to ADC disable	_	10	_	ns	Note 1	

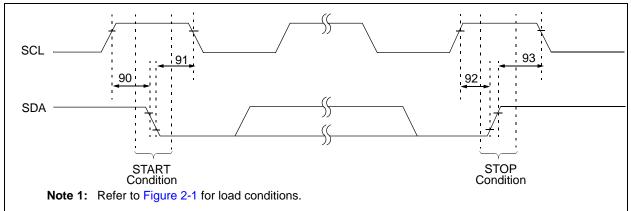
**Note 1:** This parameter is characterized, not 100% tested.

2: Data in the Typical ("Typ") column is at 5V, +25°C, unless otherwise stated..

FIGURE 2-4: HARDWARE ADDRESS LATCH TIMING



#### FIGURE 2-5: I<sup>2</sup>C BUS START/STOP BITS TIMING



#### FIGURE 2-6: I<sup>2</sup>C BUS DATA TIMING

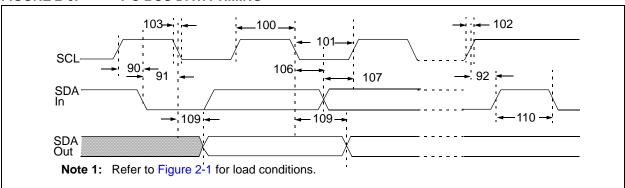


TABLE 2-4: I<sup>2</sup>C BUS DATA REQUIREMENTS (SLAVE MODE)

I <sup>2</sup> C™ A	C Characteristics	1.8V ≤ VD	Conditions (unlocations $0.5 \le 5.5$ V at $-40^{\circ}$ C, SDA) = 1 k $\Omega$ , (	$C \le TA \le$	+125°(	2	
Param No.	Characteristic	Sym	Min	Тур	Max	Units	Conditions
100	Clock High Time:	THIGH					
	100 kHz mode		4.0	_	_	μs	1.8V – 5.5V
	400 kHz mode		0.6		_	μs	1.8V – 5.5V
	3.4 MHz mode		0.06	_	_	μs	2.7V - 5.5V
101	Clock Low Time:	TLOW					
	100 kHz mode		4.7	_	_	μs	1.8V - 5.5V
	400 kHz mode		1.3	_	_	μs	1.8V - 5.5V
	3.4 MHz mode		0.16		_	μs	2.7V - 5.5V
102	SDA and SCL Rise Time:	TR					
	100 kHz mode	(Note 1)	_	_	1000	ns	1.8V - 5.5V
	400 kHz mode		20 + 0.1 CB <sup>(2)</sup>		300	ns	1.8V - 5.5V
	3.4 MHz mode		10		80	ns	2.7V - 5.5V
103	SDA and SCL Fall Time:	TF					
	100 kHz mode	(Note 1)	_	_	300	ns	1.8V - 5.5V
	400 kHz mode		20 + 0.1 CB <sup>(2)</sup>	_	300	ns	1.8V - 5.5V
	3.4 MHz mode		10	_	80	ns	2.7V - 5.5V
90	START Condition Setup Time:	Tsu:sta					l
	100 kHz mode		4.7	_	_	μs	1.8V - 5.5V
	400 kHz mode		0.6		_	μs	1.8V - 5.5V
	3.4 MHz mode		0.16	_	_	μs	2.7V - 5.5V
91	START Condition Hold Time:	THD:STA					l
	100 kHz mode		4.0	_	_	μs	1.8V - 5.5V
	400 kHz mode		0.6	_	_	μs	1.8V - 5.5V
	3.4 MHz mode		0.16	_	_	μs	2.7V - 5.5V
106	Data Input Hold Time:	THD:DAT					
	100 kHz mode		0	_	3.45	μs	1.8V - 5.5V
	400 kHz mode		0	_	0.9	μs	1.8V - 5.5V
	3.4 MHz mode		0	_	0.07	μs	2.7V - 5.5V
107	Data Input Setup Time:	TSU:DAT			•	•	1
	100 kHz mode		250	_	_	ns	1.8V - 5.5V
	400 kHz mode		100	_	<u> </u>	ns	1.8V - 5.5V
	3.4 MHz mode		0.01	_	<u> </u>	μs	2.7V - 5.5V
92	STOP Condition Setup Time:	Tsu:sto					ı
	100 kHz mode		4.0	_	_	μs	1.8V – 5.5V
	400 kHz mode		0.6	_	<u> </u>	μs	2.7V - 5.5V
	3.4 MHz mode		0.16	_	_	μs	4.5V – 5.5V

**Note 1:** This parameter is characterized, not 100% tested.

<sup>2:</sup> CB is specified from 10 to 400 (pF).

**<sup>3:</sup>** This parameter is not applicable in high-speed mode (3.4 MHz).

TABLE 2-4: I<sup>2</sup>C BUS DATA REQUIREMENTS (SLAVE MODE) (CONTINUED)

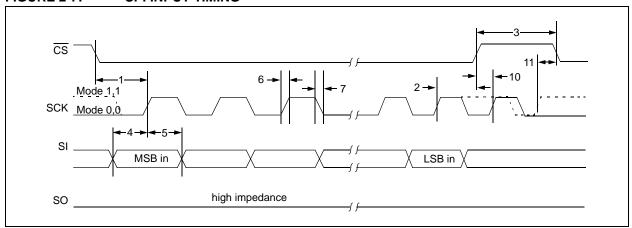
I <sup>2</sup> C <sup>™</sup> AC Characteristics		Operating Conditions (unless otherwise indicated): $1.8V \le VDD \le 5.5V$ at $-40^{\circ}C \le TA \le +125^{\circ}C$ RPU (SCL, SDA) = 1 k $\Omega$ , CL (SCL, SDA) = 135 pF.					
Param No.	Characteristic	Sym	Min	Тур	Max	Units	Conditions
109	Output Valid From Clock:	TAA					
	100 kHz mode				3.45	μs	1.8V – 5.5V
	400 kHz mode				0.9	μs	1.8V – 5.5V
	3.4 MHz mode				0.18	μs	2.7V - 5.5V
110	Bus Free Time:	TBUF (NOTE 3)					
	100 kHz mode		4.7			μs	1.8V – 5.5V
	400 kHz mode		1.3		1	μs	1.8V – 5.5V
	3.4 MHz mode		N/A		N/A	μs	2.7V - 5.5V
	Bus Capacitive Loading:	Св <b>(Note 2)</b>					
	100 kHz and 400 kHz				400	pF	(Note 1)
	3.4 MHz				100	pF	(Note 1)
	Input Filter Spike Suppression: (SDA and SCL)	TSP					
	100 kHz and 400 kHz				50	ns	(Note 1)
	3.4 MHz		_	_	10	ns	(Note 1)

**Note 1:** This parameter is characterized, not 100% tested.

2: CB is specified from 10 to 400 (pF).

3: This parameter is not applicable in high-speed mode (3.4 MHz).

#### FIGURE 2-7: SPI INPUT TIMING



## FIGURE 2-8: SPI OUTPUT TIMING

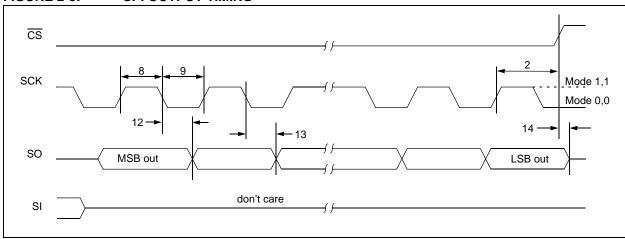
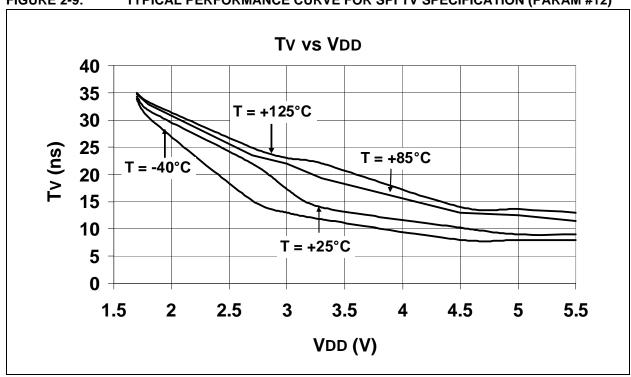


TABLE 2-5: SPI INTERFACE AC CHARACTERISTICS

SPI Interface AC Characteristics		Operating Conditions (unless otherwise indicated): $1.8V \le VDD \le 5.5V$ at $-40^{\circ}C \le TA \le +125^{\circ}C$ .					
Param No.	Characteristic	Sym	Min	Тур	Max	Units	Conditions
	Clock Frequency	FCLK	_	_	10	MHz	1.8V – 5.5V
1	CS Setup Time	Tcss	50	_	_	ns	
2	CS Hold Time	Тсѕн	50		_	ns	1.8V – 5.5V
3	CS Disable Time	TCSD	50		_	ns	1.8V – 5.5V
4	Data Setup Time	Tsu	10	_	_	ns	1.8V – 5.5V
5	Data Hold Time	THD	10	_	_	ns	1.8V – 5.5V
6	CLK Rise Time	TR	_	_	2	μs	Note 1
7	CLK Fall Time	TF	_	_	2	μs	Note 1
8	Clock High Time	Тні	45	_	_	ns	1.8V – 5.5V
9	Clock Low Time	TLO	45	_	_	ns	1.8V – 5.5V
10	Clock Delay Time	TCLD	50	_	_	ns	
11	Clock Enable Time	TCLE	50	_	_	ns	
12	Output Valid from Clock Low	Tv	_	_	45	ns	1.8V – 5.5V
13	Output Hold Time	Тно	0	_	_	ns	
14	Output Disable Time	Tois	_	_	100	ns	

Note 1: This parameter is characterized, not 100% tested.

FIGURE 2-9: TYPICAL PERFORMANCE CURVE FOR SPI TV SPECIFICATION (PARAM #12)



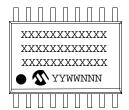
## 3.0 PACKAGING INFORMATION

# 3.1 Package Marking Information

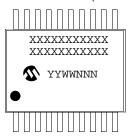
18-Lead PDIP (300 mil)



### 18-Lead SOIC (300 mil)



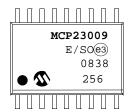
## 20-Lead SSOP (300 mil)



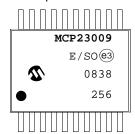
### Example:



### Example:



## Example:



Legend: XX...X Customer-specific information

Y Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')

NNN Alphanumeric traceability code

e3 Pb-free JEDEC designator for Matte Tin (Sn)

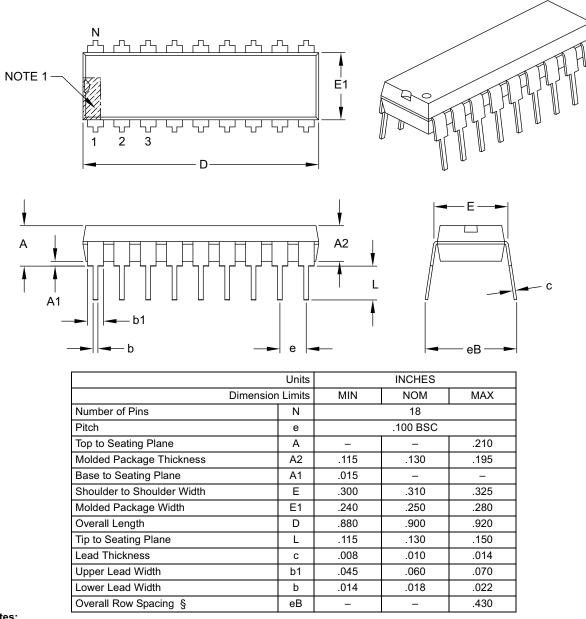
This package is Pb-free. The Pb-free JEDEC designator (e3)

can be found on the outer packaging for this package.

**Note**: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

# 18-Lead Plastic Dual In-Line (P) - 300 mil Body [PDIP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



#### Notes:

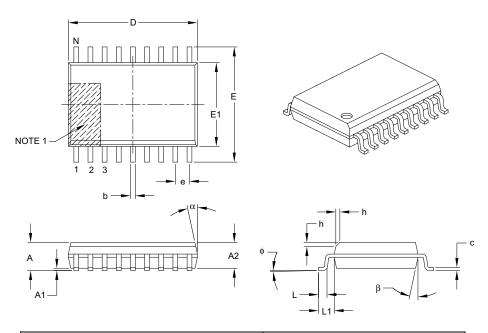
- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic.
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-007B

# 18-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS			
D	imension Limits	MIN	NOM	MAX	
Number of Pins	N		18		
Pitch	е	1.27 BSC			
Overall Height	Α	1	_	2.65	
Molded Package Thickness	A2	2.05	_	ı	
Standoff §	A1	0.10	_	0.30	
Overall Width	E	10.30 BSC			
Molded Package Width	E1	7.50 BSC			
Overall Length	D	11.55 BSC			
Chamfer (optional)	h	0.25	_	0.75	
Foot Length	L	0.40	_	1.27	
Footprint	L1 1.40 REF				
Foot Angle	ф	0°	_	8°	
Lead Thickness	С	0.20	_	0.33	
Lead Width	b	0.31	_	0.51	
Mold Draft Angle Top	α	5°		15°	
Mold Draft Angle Bottom	β	5°	_	15°	

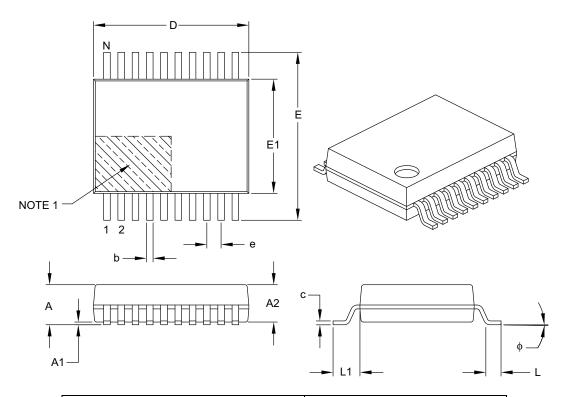
### Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic.
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
  - REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-051B

# 20-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS			
Dimensio	n Limits	MIN	NOM	MAX	
Number of Pins	N				
Pitch	е	0.65 BSC			
Overall Height	Α	_	_	2.00	
Molded Package Thickness	A2	1.65	1.75	1.85	
Standoff	A1	0.05	_	_	
Overall Width	Е	7.40	7.80	8.20	
Molded Package Width	E1	5.00	5.30	5.60	
Overall Length	D	6.90	7.20	7.50	
Foot Length	L	0.55	0.75	0.95	
Footprint	L1	1.25 REF			
Lead Thickness	С	0.09	_	0.25	
Foot Angle	ф	0°	4°	8°	
Lead Width	b	0.22	_	0.38	

### Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.
- 3. Dimensioning and tolerancing per ASME Y14.5M.
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
  - REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-072B

# **APPENDIX A: REVISION HISTORY**

# **Revision A (December 2008)**

• Original Release of this Document.

**NOTES:** 

# PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

<u>PART NO.</u> , <u>X</u> / <u>XX</u>			Examples:			
Device	Temperature Package	a)	MCP23009-E/P:	Extended Temp., 18LD PDIP package.		
	Range			Extended Temp., 18LD SOIC package.		
Device	MCP23009: 8-Bit I/O Expander w/ I <sup>2</sup> C™ Interface MCP23009T: 8-Bit I/O Expander w/ I <sup>2</sup> C Interface (Tape and Reel)	c)	MCP23009T-E/SO:	Tape and Reel, Extended Temp., 18LD SOIC package.		
	MCP23S09: 8-Bit I/O Expander w/ SPI Interface MCP23S09T: 8-Bit I/O Expander w/ SPI Interface	d)	MCP23009-E/SS:	Extended Temp., 20LD SSOP package.		
	(Tape and Reel)	e)	MCP23009T-E/SS:	Extended Temp.,		
Temperature Range	$E = -40^{\circ}C \text{ to } +125^{\circ}C \text{ (Extended) }^*$			20LD SSOP package.		
		a)	MCP23S09-E/P:	Extended Temp., 18LD PDIP package.		
Package	P = Plastic DIP (300 mil Body), 18-Lead SO = Plastic SOIC (300 mil Body), 18-Lead	b)	MCP23S09-E/SO:	Extended Temp., 18LD SOIC package.		
	SS = Plastic SSOP (5.3 mm), 20-Lead	c)	MCP23S09T-E/SO:	Tape and Reel, Extended Temp., 18LD SOIC package.		

NOTES	
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### Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the
  intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our
  knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data
  Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

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